

International Conference on Microwave and Millimeter Wave Technology 2020 (ICMMT2020) will be held in Shanghai, China on May 17-20, 2020. Technical papers describing original work in research, development, and application of all areas in microwave and millimeter wave are solicited. ICMMT2020 is organized, sponsored by Microwave Society of Chinese Institute of Electronics, Shanghai Aerospace Electronic Technology Institute, Shanghai Jiao Tong University, Fudan University, Shanghai University, East China Normal University, Science and Technology on Electronic Test and Measurement Laboratory, Science and Technology on Monolithic Integrated Circuits and Modules Laboratory, IEEE Shanghai Section, IEEE Shanghai MTT Chapter, and Kingradio Technology Co. Ltd. The accepted and presented papers will be submitted for publication in IEEE Xplore.

Important Dates

Paper Submission Deadline: Dec. 20, 2019
Acceptance Notification: Jan. 25, 2020
Advance Program Delivery: Mar. 1, 2020

Paper Submission

All submissions must be electronic in PDF format only and hard copies will not be accepted. Authors are encouraged to select one or two suggested topics listed in the scope above. All papers must be written in English and limited to 3 pages, including text, references and figures.

Student Paper Contest

Student paper contest is limited to full time students who must be the first author of the paper, and they are required to present their papers at the conference. The candidates are required to show their full time student identification cards on the registration desk. Each of the final winners will be awarded the ICMMT 2020 Best Student Paper Prize.

















Topics

Relevant topics of interest include, but not limited to the following:

- 1. Solid State Device and Circuits
- 2. Low-Noise Devices and Techniques
- 3. High-Power Devices and Techniques
- 4. Monolithic Integrated Circuits
- 5. Passive Devices and Circuits
- 6. Packaging, Interconnects, and MCMs
- 7. Ferrite and SAW Components
- 8. Superconducting Components and Technology
- 9. Microwave-Optical Design
- 10. Computer Aided Design
- 11. Instrumentation and Measurement Techniques
- 12. Electromagnetic Field Theory
- 13. Computational Electromagnetics
- 14. Microwave Antennas
- 15. Scattering and Propagation
- 16. Microwave Remote Sensing and Sensors
- 17. Microwave and Millimeter Wave Systems
- 18. High Speed Digital Circuits and SI
- 19. Biological Effects and Medical Applications
- 20. Sub-Millimeter Wave Techniques
- 21. EMI and EMC
- 22. RF Components and Systems
- 23. Wideband Gap Semiconductor Devices
- 24. PBG and Metamaterials
- 25. Other Relevant Topics



2020 China Microwave Week

International Conference on Microwave and Millimeter Wave Technology

May 17-20, 2020, Shanghai, China

http://www.em-conf.cgm/icmmt2020

中国微波周 CHINA MICROWAVE WEEK

2020

Exhibition

A large-scale exhibition of research achievements and commercial products related to the conference topics will be held concurrently.

Host

Chinese Institute of Electronics (CIE)

Organizer

Microwave Society of CIE

Shanghai Aerospace Electronic Technology Institute (SAETI)

Shanghai Jiao Tong University (SJTU)

Fudan University (FDU)

Shanghai University (SHU)

East China Normal University (ECNU)

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